2-W MONO AUDIO POWER AMPLIFIER WITH HEADPHONE DRIVE

SLOS277A - JANUARY 2000 - REVISED MARCH 2000

- Ideal for Notebook Computers, PDAs, and Other Small Portable Audio Devices
- 2 W Into 4- Ω From 5-V Supply
- 0.6 W Into 4- Ω From 3-V Supply
- Stereo Head Phone Drive
- Separate Inputs for the Mono (BTL) Signal and Stereo (SE) Left/Right Signals
- **Wide Power Supply Compatibility** 3 V to 5 V
- Meets PC99 Desktop Specs (Target)
- **Low Supply Current**
 - 11 mA Typical at 5 V
 - 10 mA Typical at 3 V
- Shutdown Control . . . 1 μA Typical
- Shutdown Pin is TTL Compatible
- -40°C to 85°C Operating Temperature Range
- Space-Saving, Thermally-Enhanced MSOP DZSC.COM **Packaging**

DGQ PACKAGE (TOP VIEW) LO/MO MONO−IN □ SHUTDOWN I III LIN V_{DD} I ☐ GND □ SR/MN BYPASS I RIN I ☐ RO/MO

description

The TPA0223 is a 2-W mono bridge-tied-load (BTL) amplifier designed to drive speakers with as low as 4- Ω impedance. The amplifier can be reconfigured on-the-fly to drive two stereo single-ended (SE) signals into head phones. This makes the device ideal for use in small notebook computers, PDAs, Digital Personal Audio players, anyplace a mono speaker and stereo head phones are required. From a 5-V supply, the TPA0223 can delivery 2-W of power into a 4- Ω speaker.

The gain of the input stage is set by the user-selected input resistor and a 50-k Ω internal feedback resistor $(A_V = -R_F/R_I)$. The power stage is internally configured with a gain of -1.25 V/V in SE mode, and -2.5 V/V in BTL mode. Thus, the overall gain of the amplifier is 62.5 k Ω / R₁ in SE mode and 125 k Ω / R₁ in BTL mode. The input terminals are high-impedance CMOS inputs, and can be used as summing nodes.

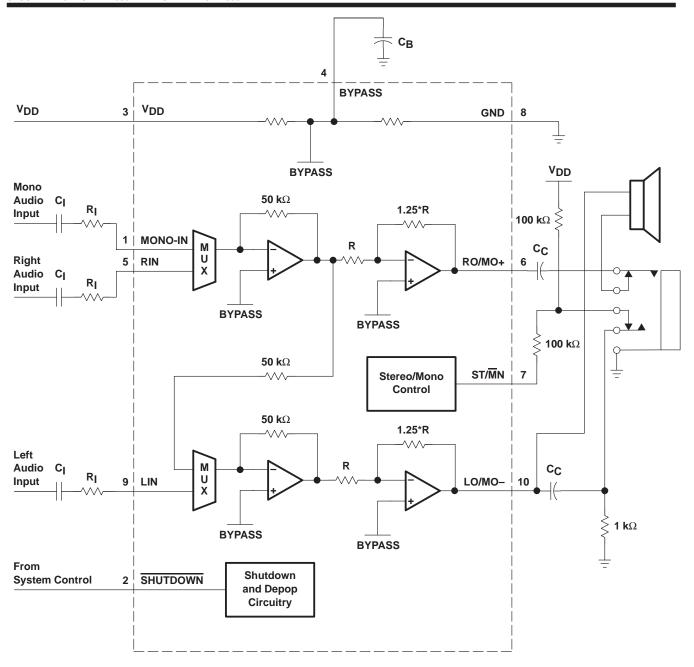
The TPA0223 is available in the 10-pin thermally-enhanced MSOP package (DGQ) and operates over an ambient temperature range of -40°C to 85°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.







AVAILABLE OPTIONS

	PACKAGED DEVICES	MSOP
T _A	MSOP† (DGQ)	SYMBOLIZATION
−40°C to 85°C	TPA0223DGQ	AEI

[†] The DGQ package are available taped and reeled. To order a taped and reeled part, add the suffix R to the part number (e.g., TPA0223DGQR).



SLOS277A – JANUARY 2000 – REVISED MARCH 2000

Terminal Functions

TERMINA	\L		DECORPORTION
NAME	NO.	1/0	DESCRIPTION
MONO-IN	1	- 1	Mono input terminal
SHUTDOWN	2	1	SHUTDOWN places the entire device in shutdown mode when held low. TTL compatible input.
V _{DD}	3	1	V _{DD} is the supply voltage terminal.
BYPASS	4	I	BYPASS is the tap to the voltage divider for internal mid-supply bias. This terminal should be connected to a 0.1 - μ F to 1 - μ F capacitor.
RIN	5	- 1	Right-channel input terminal
RO/MO	6	0	Right-output in SE mode and mono positive output in BTL mode
SR/MN	7	I	Selects between stereo and mono mode. When held high, the amplifier is in SE stereo mode, while held low, the amplifier is in BTL mono mode.
GND	8		Ground terminal
LIN	9	I	Left-channel input terminal
LO/MO	10	0	Left-output in SE mode and mono negative output in BTL mode.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)§

Supply voltage, V _{DD}	6 V
Input voltage, V _I	
Continuous total power dissipation	internally limited (see Dissipation Rating Table)
Operating free-air temperature range, T _A (see Table 3)	–40°C to 85°C
Operating junction temperature range, T _J	–40°C to 150°C
Storage temperature range, T _{Stq}	
Lead temperature 1,6 mm (1/16 inch) from case for 10 second	nds 260°C

[§] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

DISSIPATION RATING TABLE

PACKAGE	T _A ≤ 25°C	DERATING FACTOR	T _A = 70°C	T _A = 85°C
DGQ	2.14 W¶	17.1 mW/°C	1.37 W	1.11 W

[¶] Please see the Texas Instruments document, PowerPAD Thermally Enhanced Package Application Report (literature number SLMA002), for more information on the PowerPAD package. The thermal data was measured on a PCB layout based on the information in the section entitled Texas Instruments Recommended Board for PowerPAD on page 33 of the before mentioned document.

recommended operating conditions

			MIN	MAX	UNIT
Supply voltage, V _{DD}			2.5	5.5	V
	OT/141	V _{DD} = 3 V	2.7		
High-level input voltage, VIH	ST/MN	V _{DD} = 5 V	4.5		V
	SHUTDOWN		2		
	07/11/1	V _{DD} = 3 V		1.65	
Low-level input voltage, V _{IL}	ST/MN	V _{DD} = 5 V		2.75	V
	SHUTDOWN			0.8	
Operating free-air temperature, T _A			-40	85	°C



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SLOS277A – JANUARY 2000 – REVISED MARCH 2000

electrical characteristics at specified free-air temperature, V_{DD} = 3 V, T_A = 25°C (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
IVool	Output offset voltage (measured differentially)				30	mV
I _{DD}	Supply current			10	13	mA
IDD(SD)	Supply current, shutdown mode			1	10	μΑ

operating characteristics, V_{DD} = 3 V, T_A = 25°C, R_L = 4 Ω

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
D-	PO Output power, see Note 1		BTL mode			660		mW
F0			SE mode,	$R_L = 32 \Omega$		33		IIIVV
THD + N	Total harmonic distortion plus noise	$P_0 = 500 \text{ mW},$	f = 20 Hz to 20 kHz			0.3%		
ВОМ	Maximum output power bandwidth	Gain = 2,	THD = 2%			20		kHz

NOTE 1: Output power is measured at the output terminals of the device at f = 1 kHz.

electrical characteristics at specified free-air temperature, V_{DD} = 5 V, T_A = 25°C (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
IVool	Output offset voltage (measured differentially)				30	mV
I _{DD}	Supply current			11	15	mA
I _{DD(SD)}	Supply current, shutdown mode			1	10	μΑ

operating characteristics, V_{DD} = 5 V, T_A = 25°C, R_L = 4 Ω

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
Do Output power and Note 4		THD = 1%,	BTL mode			2		W
PO Output power,	Output power, see Note 1	THD = 0.1%,	SE mode,	$R_L = 32 \Omega$		95		mW
THD + N	Total harmonic distortion plus noise	P _O = 1 W,	f = 20 Hz to 20 kHz			0.2%		
ВОМ	Maximum output power bandwidth	Gain = 2.5,	THD = 2%			20		kHz

NOTE 1: Output power is measured at the output terminals of the device at f = 1 kHz.

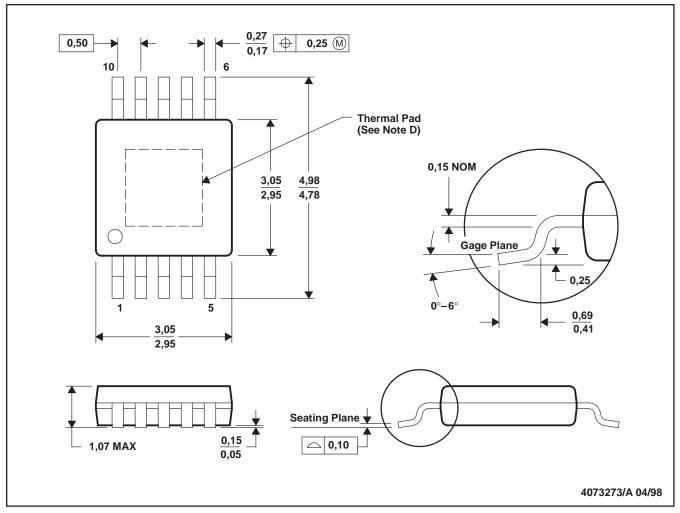


SLOS277A – JANUARY 2000 – REVISED MARCH 2000

MECHANICAL DATA

DGQ (S-PDSO-G10)

PowerPAD™ PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion.
- D. The package thermal performance may be enhanced by bonding the thermal pad to an external thermal plane. This pad is electrically and thermally connected to the backside of the die and possibly selected leads.

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